

4/4/03 3BG

L Number	Hits	Search Text	DB	Time stamp
1	2024	428/209.cccls.	USPAT	2003/04/04 16:20
2	516	428/209.cccls. and (copper and nickel)	USPAT	2003/04/04 16:25
3	11	(428/209.cccls. and (copper and nickel)) and ((rolling adj reduction) or (cold adj press) or (press adj bond\$3))	USPAT	2003/04/04 17:02
4	1702	428/675.cccls. or 428/678.cccls. or 428/680.cccls.	USPAT	2003/04/04 16:25
5	517	(428/675.cccls. or 428/678.cccls. or 428/680.cccls.) and (copper and nickel)	USPAT	2003/04/04 16:26
6	12	((428/675.cccls. or 428/678.cccls. or 428/680.cccls.) and (copper and nickel)) and ((rolling adj reduction) or (cold adj press) or (press adj bond\$3))	USPAT	2003/04/04 16:29
8	1725	(29/17.1).cccls. or (29/17.2).cccls. or (29/17.3).cccls. or (29/592.1).cccls. or (29/825).cccls.	USPAT	2003/04/04 16:31
9	1018	(29/527.5) or (29/527.7).cccls.	USPAT	2003/04/04 16:31
12	105	((29/527.5) or (29/527.7).cccls.) and (copper and nickel)	USPAT	2003/04/04 16:32
14	5	(((29/527.5) or (29/527.7).cccls.) and (copper and nickel)) and ((rolling adj reduction) or (cold adj press) or (press adj bond\$3))	USPAT	2003/04/04 16:32
13	2	(((29/17.1).cccls. or (29/17.2).cccls. or (29/17.3).cccls. or (29/592.1).cccls. or (29/825).cccls.) and (copper and nickel)) and ((rolling adj reduction) or (cold adj press) or (press adj bond\$3))	USPAT	2003/04/04 16:32
11	151	(((29/17.1).cccls. or (29/17.2).cccls. or (29/17.3).cccls. or (29/592.1).cccls. or (29/825).cccls.) and (copper and nickel)) and ((copper and nickel)) and (substrate or interposer or (clad adj plate))	USPAT	2003/04/04 16:34
15	25	(((29/527.5) or (29/527.7).cccls.) and (copper and nickel)) and (substrate or interposer or (clad adj plate))	USPAT	2003/04/04 16:37
16	78	(((29/17.1).cccls. or (29/17.2).cccls. or (29/17.3).cccls. or (29/592.1).cccls. or (29/825).cccls.) and (copper and nickel)) and (substrate or interposer or (clad adj plate))	USPAT	2003/04/04 16:58
19	393	438/121.cccls.	USPAT	2003/04/04 16:47
20	90	438/121.cccls. and (copper and nickel)	USPAT	2003/04/04 16:57
21	1763	361/748.cccls. or 361/751.cccls. or 361/752.cccls. or 361/757.cccls.	USPAT	2003/04/04 16:58
22	176	(361/748.cccls. or 361/751.cccls. or 361/752.cccls. or 361/757.cccls.) and (copper and nickel)	USPAT	2003/04/04 17:01
23	131	((361/748.cccls. or 361/751.cccls. or 361/752.cccls. or 361/757.cccls.) and (copper and nickel)) and (substrate or interposer or (clad adj plate))	USPAT	2003/04/04 16:58
24	49	(((361/748.cccls. or 361/751.cccls. or 361/752.cccls. or 361/757.cccls.) and (copper and nickel)) and (substrate or interposer or (clad adj plate))) and (copper with film)	USPAT	2003/04/04 16:58
25	6	(((361/748.cccls. or 361/751.cccls. or 361/752.cccls. or 361/757.cccls.) and (copper and nickel)) and (substrate or interposer or (clad adj plate))) and (copper adj film)	USPAT	2003/04/04 17:01
27	2782	174/68.1.cccls. or 174/255.cccls. or 174/256.cccls. or 174/257.cccls. or 174/260.cccls.	USPAT	2003/04/04 17:01
28	611	(174/68.1.cccls. or 174/255.cccls. or 174/256.cccls. or 174/257.cccls. or 174/260.cccls.) and (copper and nickel)	USPAT	2003/04/04 17:01
29	47	((174/68.1.cccls. or 174/255.cccls. or 174/256.cccls. or 174/257.cccls. or 174/260.cccls.) and (copper and nickel)) and (copper adj film)	USPAT	2003/04/04 17:01

30	2	((174/68.1.cccls. or 174/255.cccls. or 174/256.cccls. or 174/257.cccls. or 174/260.cccls.) and (copper and nickel)) and (copper adj film) and ((rolling adj reduction) or (cold adj press) or (press adj bond\$3))	USPAT	2003/04/04 17:03
36	4	(("6032362") or ("5736234") or ("6150037") or ("5482784")).PN.	USPAT	2003/04/04 17:08
-	84298	copper and nickel	USPAT	2003/03/26 18:13
-	166	(copper and nickel) and (rolling adj reduction)	USPAT	2003/01/28 17:18
-	56010	(copper and nickel) and (copper with nickel)	USPAT	2003/01/28 17:18
-	110	((copper and nickel) and (copper with nickel)) and (rolling adj reduction)	USPAT	2003/01/28 17:18
-	7	((copper and nickel) and (copper with nickel)) and (rolling adj reduction)) and semiconductor	USPAT	2003/01/28 17:19
-	238	(copper adj foil) and (nickel adj foil)	USPAT	2003/01/28 17:20
-	115	(copper adj foil) with (nickel adj foil)	USPAT	2003/01/28 17:20
-	4	((copper adj foil) with (nickel adj foil)) and (rolling adj reduction)	USPAT	2003/01/28 17:20
-	1701	428/675.cccls. or 428/678.cccls. or 428/680.cccls.	USPAT	2003/04/04 16:25
-	2022	428/209.cccls.	USPAT	2003/03/26 18:13
-	515	(428/675.cccls. or 428/678.cccls. or 428/680.cccls.) and (copper and nickel)	USPAT	2003/03/26 18:14
-	4	(copper adj foil) and (nickel adj foil) and (rolling adj reduction)	USPAT	2003/03/26 18:14
-	116061	29/\$.cccls.	USPAT	2003/03/26 18:15
-	60	29/\$.cccls. and (rolling adj reduction)	USPAT	2003/03/26 18:15
-	12	(29/\$.cccls. and (rolling adj reduction)) and (copper and nickel)	USPAT	2003/03/26 18:16
-	1	(29/\$.cccls. and (rolling adj reduction)) and semiconductor	USPAT	2003/03/26 18:16